# Trigger system in ATLAS: Prospects for Argentina to contribute with developments for the LHC Phase II upgrades.

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Fundamental Meets Technology



### Large Hadron Collider



### Large Hadron Collider

#### **Specifications**

- Is a hadron collider (proton-proton, proton-lead, lead-lead nuclei)
- Built 100m underground, 27km circumference
- 14 TeV nominal centre of mass energy (operating currently at 13 TeV)
- Superconducting Magnets of 8T (13K5 Amps electric current) to keep the protons on track
- Magnets operate cooled down with liquid helium at  $1.9^{\circ}K \rightarrow -271^{\circ}C$
- Full volume of beam pipes at  $10^{-13}$  Atm vacum



- Multipurpose detector
- 46m length x 25m diameter x 7000 Tons (the weight of the Eiffel tower)
- 100m underground at the LHC



#### ATLAS has different subdetectors:

• Inner detector  $\rightarrow$  Tracking





- Measure the tracks of charged particles
- More than 90M channels to read out
- IBL+pixel detector+SCT+TRT

#### ATLAS has different subdetectors:

- Inner detector  $\rightarrow$  Tracking
- Calorimeters





- A Lead/Liquid Argon (LAr) high granularity EM calorimeter. (absorbers/sampling material).
- High precision for electrons/photons energy/shower shape measurements
- An iron/Plastic Scintilators complemented by copper/LAr for Hadronic calorimetry.
- Tungsten/LAr covering the Forward region.
- Up to eta=4.9 coverage.

#### ATLAS has different subdetectors:

- $\bullet \ \text{Inner detector} \to \text{Tracking}$
- Calorimeters
- Muon detectors





• MDT and CSC chambers plus RPC and TGC trigger



### ATLAS trigger system

#### Why a trigger system?

- The new physics events are very rare
- That is why the LHC makes a large number of collisions (40M/sec)
- We can only store the information of the relevan ones ( $\sim$  1000/s)

#### Trigger system decides online whether or not to keep an event

Crucial impact on quality of data used in physics analysis!

## ATLAS Trigger System during Run-2 at the LHC incorporates several upgrades and improvements since Run-1 to cope with:

- Higher rates
- More interactions per bunch crossing (pile-up)
- Higher centre-of-mass energy collisions (from 7/8 TeV  $\rightarrow$  13 TeV)
- Higher instantaneous luminosty





### ATLAS TDAQ system



### ATLAS TDAQ system



- Upgraded L1 Calo, L1 Muon and CTP (Central Trigger Processor)
  - L1 Calo: new Multi-Chip Module (nMCM) allows more flexible signal processing, more thresholds
  - L1 Muon: coincidences with inner detector, additional chambers in the feet of the barrel region and from Tile extended barrel region
  - CTP: more resources, support multi-partition running
- L1Topo
  - Allows for topological selections between L1 trigger objects (e.g.  $\Delta R$ ) to keep L1 thresholds low

### ATLAS TDAQ system



- Single farm (merged L2-EF) for better resource sharing and overall simplification
- Fast offline-like algorithms running mostly in L1 RoIs

Calorimeter detector

- Average 350 ms latency
- Full upgrade of readout and data storage systems
- ~1 kHz of physics (full event building) output rate achieved
- Partial event building used for Trigger Level Analysis, detector monitoring and calibrations
- Once HLT is passed, the event is accepted and written into data streams
- Then offline software is run at Tier-0 to reconstruct the objects



### <u>Triggering $e/\gamma$ in ATLAS as a test case</u>



- $E/\gamma$  trigger is based on reconstructing objects within a Region of Interest (RoI)
  - Level 1 Electromagnetic (L1 Calo) trigger seeds the Rol for the High Level Trigger (HLT)

### $\bullet$ E/ $\gamma$ HLT algorithms reconstruct and identify

- Clusters
- Tracks
- Photons Electromagnetic (EM) Cluster
- Electrons EM Cluster + Track

### • $E/\gamma$ HLT algorithm flow

- Fast algorithms rejects event early
- Precise algorithms to efficiently identify  ${\rm e}/\gamma$

#### • $E/\gamma$ Reconstruction, calibration and identification

Offline software and techniques



Precise e/v Selection

Fast

### Level 1 EM trigger

### Run-2

- Improved Signal Processing: new Multi-Chip-Module (nMCM)
  - Improved energy resolution (noise auto-correlation filtering)
  - Dynamical pedestal correction
- Clustering: Cluster Processor Module (CPM) firmware
  - $E_T$  -dependent electromagnetic/hadronic isolation cuts with  $\Delta E_T \sim 0.5~{\rm GeV}$  precision
- Counting: New extended Common Merger Module (CMX)
  - Doubles max number of E<sub>T</sub> thresholds to 16
  - $E_T$  thresholds can have  $\Delta\eta$ =0.1 in granularity



#### While during Run-1

- $\eta$ -dependent  $E_T$  thresholds  $\rightarrow \Delta \eta$ =0.4 granularity
- $\bullet\,$  Fixed Isolation cut  $\rightarrow$  Hadronic-core isolation H  $\leq 1~GeV$
- EM Isolation not used (but available) during Run-1

### **Electrons and photons at HLT**



- Energy of an  $e/\gamma$  candidate built with cluster of cells in EM calorimeter
- $\bullet$  Local maximum required for a cluster seed  $\rightarrow$  sliding window algorithm
- Photons are reconstructed with only the cluster
- Common shower shape variables for  $e/\gamma$  calculated for identification



### **Energy Calibration at HLT**

- EM cluster properties (longitudinal development) are calibrated to the original energy of the electron and photon in Monte Carlo (MC) samples
- MC samples are used to determine the e/y response calibration where the constants are determined in a multivariate algorithm
- Good agreement between data and MC







### Identifying $e/\gamma$

- Common set of shower shape variables used to identify electrons and photons
  - EM shower can be characterised by the longitudinal (depth) and lateral (width) shapes
  - $e/\gamma$  use same variables, but different cut values

### Variables and Position

	Strips	2nd	Had.
Ratios	f1, fside	$R_{\eta}^*, R_{\phi}$	R <sub>Had</sub> .*
Widths	Ws,3, Ws,tot	$W_{\eta,2}^*$	X.Z
Shapes	$\Delta E$ , $E_{ratio}$	* Used in	PhotonLoose.



#### Identification of photons and electrons

- Optimised in bins of  $E_T$  and  $\eta$
- Several levels of discrimination with higher efficiency but lower purity (loose, medium, tight)

### • Electron identification incorporates tracking information

- Transition radiation hit information
- Track quality & Track-cluster matching

### **Shower Shapes**







### Improved Electron ID for Run-2

#### Rate depends strongly on Electron trigger threshold

- Physics potential suffers as threshold increases
- Run-2 improve purity and reduce background with tighter selections and multivariate techniques

#### Electron Likelihood (LH) Particle Identification

- Introduced a NN ringer algorighm for fast identification
- Same as offline ID on precise reconstruction
- Relies on same variables as cut-based selection
- LH tuned to same signal efficiency as a cut-based selection
  - Factor 2 improvement in background rejection
  - Higher signal purity
  - $\bullet\,$  LH discriminant is  $<\mu>$  dependent to kepp high efficiency at high pileup

$$d\mathcal{L} = rac{\mathcal{L}_S}{\mathcal{L}_S + \mathcal{L}_B}, \mathcal{L}(ec{x}) = \prod_{i=1}^n P_{s,i}(x_i)$$

### **Electron Trigger Performance**

#### Likelihood electron selection out-performs cut-based selection in Run-2

- LH selection efficiency 4-6% higher than cut-based selection
- Likelihood trigger out-performs cut-based when measured with respect to any offline identification
  - Tight selection 45% rate reduction with 7% efficiency loss w.r.t. cut-based
- Excellent Data-MC agreement



### Photon Trigger Performance

#### Photon performance of Run-2 similar to Run-1

- $\bullet\,$  Photon ID uses cut-base selection as in Run-1  $\to$  reoptimized for Run-2 higher  $\sqrt{s}$  and instantaneous luminosity
- Incorporated medium Id working point at trigger level, in addition to loose and tight
  - Medium includes lateral Energy ratio in first layer to discriminate  $\gamma$  from  $\pi^0 o \gamma\gamma$
- Introduced topological cluster isolation for photon triggers
- Lowest threshold unprescaled triggers up to  $L = 1.2 \times 10^{34} cm^{-2} s^{-1}$ :
  - g35\_medium\_g25\_medium
  - g140\_loose



### LHC/HL-LHC

- 2019 2020 is LS2 to get ready for Run3: 14 TeV and higher inst luminosities  $\rightarrow$  Phase-I
- The HL-LHC project is planned to begin collisions by 2026
- ATLAS will collect an integrated luminosity of 3000-4000 fb<sup>-1</sup>in 10 years
- HL-LHC upgrades will happen during Long Shutdown 3 (2024-2026)



### **TDAQ system being updated for next run: Phase-I**

#### Phase-I upgrade $\rightarrow$ meets the needs for Run3

- More background rejection for  $e_{\gamma}$  trigger through the upgrade of the EM trigger electronics
- Better muon reconstruction and fake rejection in muon endcap by installing new precision and high efficiency detectors in a New Small Wheel
- FTK (Fast TracKer): full-event hardware-based (Associative memory and FPGAs) track reconstruction during event processing at the HLT CPU farms

#### Pileup conditions at HL-LHC $\rightarrow$ 10 times more rate

Limitations of Phase-I system among others:

- The readout bandwidth is limited by the detector front-end electronics
- The Level-1 trigger rate can't go higher than 100kHz
- Phase-I system latency is insufficient to implement more powerful selection algorithms in order to reduce the trigger rate



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- Stand the 5-7 10<sup>34</sup>/cm<sup>2</sup>/s instantaneous luminosity is beyond the capabilities of the current detectors
- Replace several parts (like full inner detector!) to achieve a robuster, faster, radiation harder and lighter detector.
- Goal : have the same-or better-performances in HL-LHC harsh conditions than in Run2
- Upgrade: fruit of permanent feedback between physics requirements and detectors component design



- Protect against high fluencies. Needs more radiation hard eletronics design.
- Mitigate pileup rates and occupancy
- Keep low  $p_{\mathrm{T}}$  requirements for main triggers
- Guarantee precise measurements up to large rapidity
- Lighten the detector, dropping material

### **HL-LHC collisions plans**

# Ultimate scenario 7.5 10<sup>34</sup>: 320 fb<sup>-1</sup>/y for 160 days ions collisions end at LS4

### Physics days: 160 Run4 $\rightarrow$ 200 Run5 $\rightarrow$ 220 Run6



### Some requirements

- TDAQ ATLAS system needs to be upgraded to cope with HL-LHC conditions
- Part of what is currently computed at the HLT would need to be achieved computed at Hardware trigger
- Some of the parameters (including contingency) required for TDAQ @HL-LHC:

Parameter	Phase-II value
Clock frequency	40.08 MHz
Level-0 trigger rate	1 MHz
Minimum interval between two L0A signals	0 BC
Consecutive Level-0 triggers	$\leq$ 4 L0A in 5 BC
Level-0 burst size	$\leq$ 8 L0A in 0.5 $\mu  m s$
	$\leq$ 128 L0A in 90 $\mu  m s$
Maximum skew between all calorimeter inputs to L0Calo FEXs	16 BC
Level-0 latency	10 µs
Calorimeter data reception in L0Calo & L0Muon processors	$1.7\mu s$
High Granularity Calorimeter data reception in Level-0	$1.7\mu s$
Seeding Muon detector data reception in L0Muon	$1.7\mu s$
Precision Muon detector data reception in L0Muon	2.8 µs
Deadtime	<0.1% per detector system

### **TDQ Phase-II upgrade**

#### Many complex analysis on real time at hardware trigger

#### Among other aspects

- L0 Calo will include electron FeatureExtractor (eFEX), jet (jFEX), global (gFEX) and forward jet (fFEX), all implemented in FPGA hardware
- Global trigger will replace current L1-Topo, get inputs from L0 Calo and muons to make a decision
- Common hardware, specialized firmware
- Access to full calorimeter data

#### Not just TDAQ needs to be updated

#### Upgrade of LAr electronics

- The LAr calorimeters themselves are expected to operate reliably during the HL-LHC data-taking period
- But the current electronics is not compatible with operations at HL-LHC
- All front-end and back-end electronics will be replaced



### La Plata and the upgrades



# We were deeply involved for Phase-I studies This study showed how improvement in the calorimeter granularity at L1 could lead to high

efficiency and high background rejection of electron and photons

#### **Studies for Phase-II**

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- Made occupancy studies of the detector at mu=200
- Under some assumptions, by merging events in 2016 data
- Estimations on rates and readout requirements (preliminary and non-public, can't be shown here)

### Phase-II involvement, plans and opportunities for Argentina

#### **Global trigger**

- We are joining the effort to collaborate in development of HW/FW for the Global Trigger
- Hiring and engineer (CPA-CONICET) to full time contribute on this R&D effort
- The aim is to build hardware in Argentina, once Phase-II production starts. What and how much each institution builds is under discussion with the ATLAS collaboration, final decision during this year.

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- In such case we would need to be able to produce and build multi-layer high speed boards with high-end FPGAs
- Likely, in addition, we will be responsible of R&D and production of a module of signal distribution (local industries play a role here)

#### New facility at new Institute building

- IFLP is moving to new building, equipped with a specific electronics lab for this project (and future ones)
- Starting to equip it. (High end Computers, high speed Oscilloscopes, high speed random signal generators and FPGA evaluation kit)

#### New responsibilities

 Just joint with Oregon the effort of coordinating Global Trigger algorithm developments for trigger signatures

### **Conclusions**

#### Run-2

- As members of the e/gamma trigger group we have contributed with ATLAS in performance measurements, selection tuning, deployment of optimizations at the HLT and operation
- Contributed to studies for the Phase-I LoI and studies related to Phase-II

#### Phase-II: A step forward for Argentina contribution to ATLAS

- Provide in kind contribution to TDAQ Phase-II upgrade
- Full time Engineer to collaborate in Global Trigger Hardware/Firmware
- Aim is to build some of Global modules in Argentina
- In addition to some specific hardware for signal distribution

Special opportunity for local high-end electronics industry